YAMAHA L 5 I

YTD423

IHDLC2

ISDN BRI controller with B-ch HDLC controllers

1 INTRODUCTION

YTD423 is a high-performance communication LSI for the ISDN BRI user-network interface function (digital four-wire time-division full-duplex operation), supporting D-channel layer 1, layer 2 and HDLC controller for Bchannels, all in one 100-pin SQFP chip. YTD423 supports layer 1 (physical layer) control function conforming to ITU-T Recommendation I.430 and fully supports layer 2 (LAP-D protocol) function conforming to ITU-T Recommendations Q.920 and Q.921. ETSI (European Telecommunications Standards Institute) and several North American standard operating modes are also supported. In addition, YTD423 includes layer 3 processor interface function and 2-channel HDLC controller for B-channels, which operate in DMA transfer mode or I/O transfer mode. This gives a great advantage to mounting and functional designing of both "active" (with CPU on board) terminal equipment and "passive" (no CPU on board) PC cards. In order to support the U interface, YTD423 has a TTL interface (no built-in analog driver/receiver) suitable for connecting to an NT1 chip or a DSU module. S/T reference point can also be supported by connecting it to YTD421 (analog driver/receiver LSI).

1.1 Features

- 1. Layer 1 function
 - Supports layer 1 control function conforming to ITU-T Recommendation I.430 [1992 edition] and TTC Standard JT-I430 [1993 edition] (default)
 - TTL interface
 - 192 kbps transmission rate
 - Interface structure : 2B + D (B = 64 kbps, D = 16 kbps)
 - Frame assembling and disassembling function
 - Collision control (built-in random number (Ri) reset), priority control (built-in retransmission control), and state transition control
 - Programmable T3 and T4 timers

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- Supports ETSI ETS 300 012 [April 1992] and ANSI T1.605 operating modes
- Leased line capability (JT-I430-a)
- B channel I/O clock selection function
 - Internal clock mode: Inputs/outputs the B-channel data with 64 k, 56 k or 32 kHz internal clock
 - External clock mode (PCM Highway mode): Inputs/outputs the B channel data with a 128 kHz to 2048 kHz external clock
- B channel selection function
 - Internal clock mode: Selects/switches B channel I/O pins
 - External clock mode (PCM Highway mode): Selects/switches B channel time slots
- Multiframing capability
- Abundant Test functions (for testing and maintenance)
 - Three kinds of loop-back modes (Loop-back 1 to 3)
 - INFO signals output for testing
 - Test pulse output for pulse shape evaluation
- INFO1 transmission and INFO4 reception monitor pins
- SLEEP monitor pin
- I.430 transmission frame phase adjustment function

2. Layer 2 function

- Conforms to ITU-T Recommendation Q.920 and Q.921 [1992 edition] and TTC Standard JT-Q920 and JT-Q921 [1993 edition] (default)
 - HDLC frame control (Flag control, FCS generation/checking, automatic zero insertion/deletion, abort pattern transmission/detection, etc.)
 - LAP-D status control (sequence control, flow control, SAPI control)
 - Built-in timer for time-out check
- Supports ETSI ETS 300 125 [September 1991], National ISDN-1/2, AT&T 5ESS 5E9 and Nortel DMS-100 S208-6 operating modes
- Multi-link capability (circuit switching, packet switching)
- Automatic assigned TEI/non-automatic assigned TEI (VC/PVC)
- Leased line mode (disable layer 2 function)

3. Layer 3 interface function

- Connects to 8-bit or 16-bit microprocessor (8086 family, Z80 family, 6800 family and 68000 family)
- Operates in one of two data transfer modes
 - DMA transfer mode (with the built-in 24-bit address DMA controller)
 - I/O transfer mode (with the built-in FIFO)
- Primitive logical interface



- 4. HDLC controller for B-channels
 - HDLC frame control (Flag control, optional marks or flags in idle state, optional FCS generation/checking, automatic zero insertion/deletion, abort pattern transmission/detection, optional address field generation/checking etc.)
 - \bullet Full-duplex communication \times 2 channels
 - Data rates Network synchronization clock mode: 56 k or 64 kbps Network independent clock mode: Up to 128 kbps
 - Optional 16-bit/32-bit CRC
 - Programmable data transfer modes
 - DMA transfer mode (with the built-in DMA controller)
 - * optional 8-bit/16-bit access
 - * 24-bit address
 - * 4 channels
 - I/O transfer mode (with the built-in FIFO)
 - * Tx FIFO : 32 bytes \times 2 * Rx FIFO : 64 bytes \times 2
 - * Variable interrupt levels
 - * variable interrupt levels
 - * Byte/Word access selection
 Optional transparent mode (disable HDLC controller function)
- 5. Low-power operation (the host processor clock control function, LSI internal clock freezing function)
- 6. CMOS technology
- 7. 100-pin SQFP
- 8. Single +5V volt supply

1.2 Applications

- Terminal Adapter (TA)
- Router
- ISDN PC Card
- PBX
- ISDN Telephone

2 BLOCK DIAGRAM

2.1 User Network Interface Block Diagram

YTD423 is the most-suited LSI for terminal equipment such as terminal adapters and ISDN telephones and for PHS base stations. YTD423 contains layer 1 and layer 2 functions as well as the HDLC controller and DMA controller for the B channel. Because of this, terminal equipment can be optimally configured by adding few circuits such as the layer 3 control processor and analog driver/receiver.

The block diagram of the user network interface with YTD423 is shown in Figure 1.

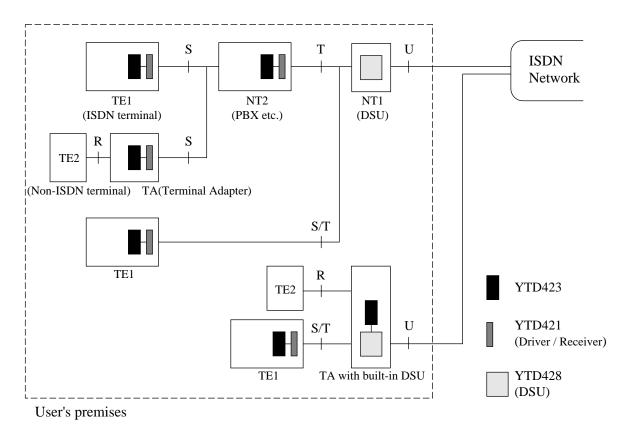


Figure 1: User Network Interface Block Diagram

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2.2 YTD423 Peripheral LSI Interface Block Diagram

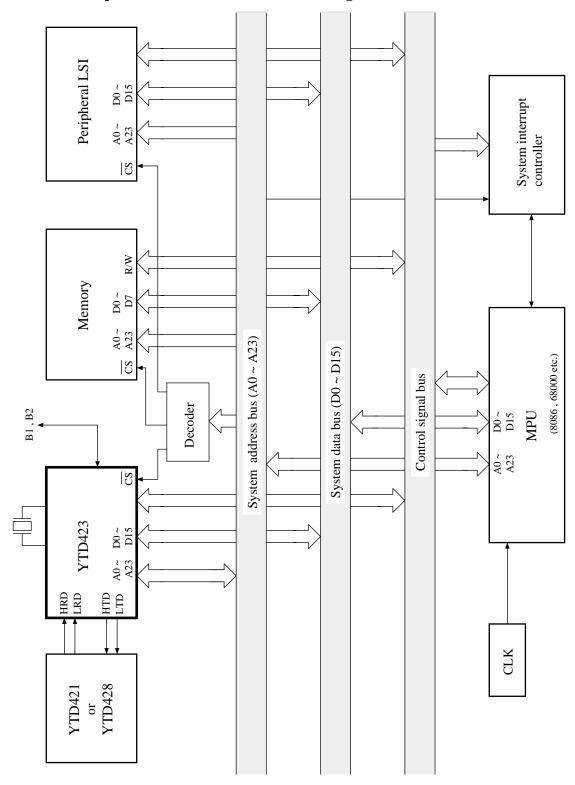


Figure 2: Peripheral LSI Interface Block Diagram

2.3 YTD423 Internal Block Diagram

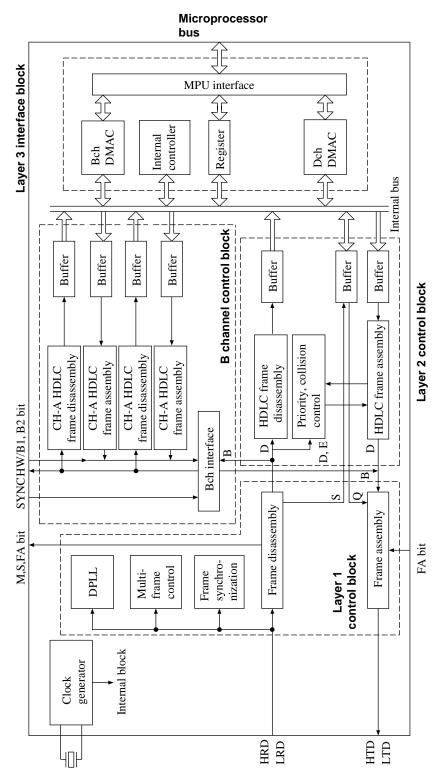


Figure 3: Internal Block Diagram

3 Pin Assignments

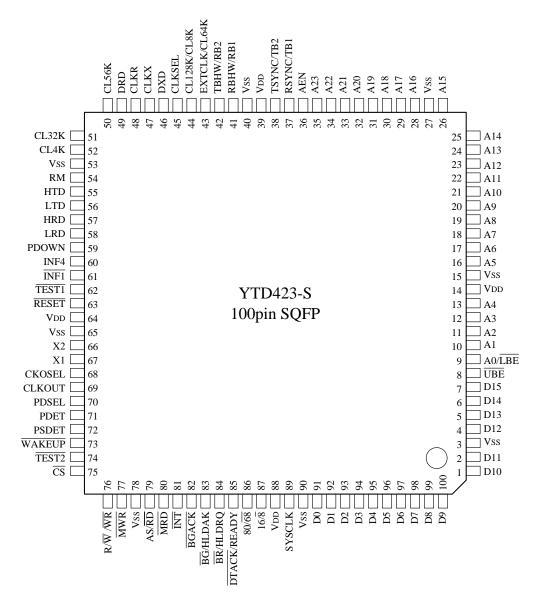


Figure 4: YTD423-S (100-pin SQFP) Pin Assignments

ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings 4.1

Parameter	Symbol	Min.	Max.	${f Units}$
Supply Voltage	$ m V_{DD}$	-0.3	+7.0	V
Input Voltage	$ m V_{IN}$	-0.3	$V_{ m DD}\!+\!0.3$	V
Operating Temperature	T_{op}	-20	+70	$^{\circ}\mathbf{C}$
Storage Temperature	${ m T_{stg}}$	-50	+125	$^{\circ}\mathrm{C}$

 $(Based\ on\ V_{\rm SS}\,=\,0.0\ V)$

4.2Recommended Operating Conditions

5 V \pm 5 % (Based on $V_{SS}=0.0V)$ -20 - 70 $^{\circ}\mathrm{C}$ Supply Voltage

Operating Temperature



4.3 DC Characteristics

 $(V_{\rm DD}$ = 5 V \pm 5%, $T_{\rm op}$ = -20 - 70 $^{\circ}C)$

Parameter	Symbol	Condition	Min.	Typ.	Max.	${f Units}$
High-Level Input Voltage (CMOS)	V_{IH}	(Note 1)	$0.8 m V_{DD}$			V
Low-Level Input Voltage (CMOS)	$ m V_{IL}$	(Note 1)			$0.2\mathrm{V_{DD}}$	V
High-Level Input Voltage (TTL)	$ m V_{IH}$	(Note 2)	2.2			V
Low-Level Input Voltage (TTL)	$ m V_{IL}$	(Note 2)			0.8	V
High-Level Output Voltage (CMOS)	$ m V_{OH}$	$ { m I}_{ m OH} < 10 \mu{ m A}$	$ m V_{DD}{-}0.4$			V
Low-Level Output Voltage (CMOS)	$ m V_{OL}$	$ { m I}_{ m OL} < 10 \mu{ m A}$			$V_{\rm SS}\!+\!0.4$	V
High-Level Output Voltage (TTL)	$ m V_{OH}$	(Note 3)	2.7			V
Low-Level Output Voltage (TTL)	$ m V_{OL}$	(Note 3)			0.4	V
Low-Level Output Voltage (Open-D)	$ m V_{OL}$	(Note 4)			0.4	V
Leakage Current	${ m I_L}$		-10		10	$\mu\mathrm{A}$
Off-State Leakage Current	$ m I_{LZ}$	(Note 5)	-10		10	$\mu\mathrm{A}$
Power Supply Current	$ m I_{DD}$	(Note 6)		17		mA
		(Note 7)		0.2		mA

Note 1: With respect to X1, RESET, TEST1, TEST2, WAKEUP, PDET, CLKSEL, PSDET pins.

Note 2: With respect to other pins.

Note 3: CLKOUT pin Test condition: $I_{OH} = -1.0$ mA, $I_{OL} = 2.0$ mA other output pins Test condition: $I_{OH} = -0.4$ mA, $I_{OL} = 1.2$ mA

Note 4: $\frac{\text{HTD}}{\text{INF1}}$ pin $\frac{\text{Test condition}}{\text{Test condition}}: I_{\text{OL}} = 1.2 \text{ mA}$ $\frac{1}{\text{INF1}}$ pin $\frac{1}{\text{Test condition}}: I_{\text{OL}} = 3 \text{ mA}$

RBHW pin $\mbox{Test condition}: \, \mbox{I}_{\rm OL} \, = \, 0.8 \, \, \mbox{mA}, \, \mbox{R}_{\rm L} \, = \, 500 \, \, \Omega$

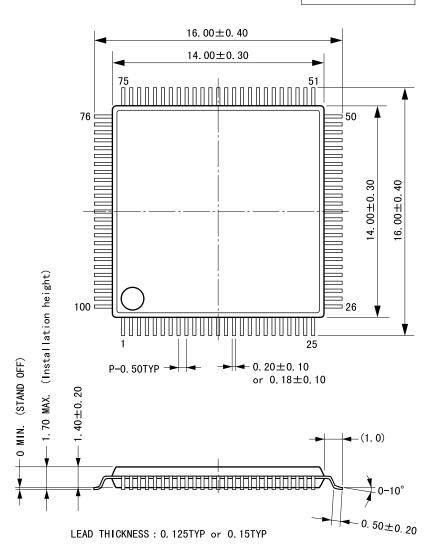
Note 5: With respect to cases in which D0-D15, A0-A23, and $\overline{\text{UBE}}$ pins are in the input state and $\overline{\text{MWR}}$ and $\overline{\text{MRD}}$ pins are in Hi-Z state.

Note 6: RUN state (SYSCLK = 8 MHz)

Note 7: SLEEP state

5 PACKAGE OUTLINE





(UNIT) : mm (millimeters)

The shape of the $\,$ molded corner may slightly different from the shape in this diagram.

The figure in the parenthesis () should be used as a reference. Plastic body dimensions do not include burr of resin. UNIT: \mbox{mm}

(Note) The LSIs for surface mount need special consideration on storage and soldering conditions. For detailed information, please contact your nearest Yamaha agent.

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